### 16-Bit I/O Expander with Serial Interface

#### **Features**

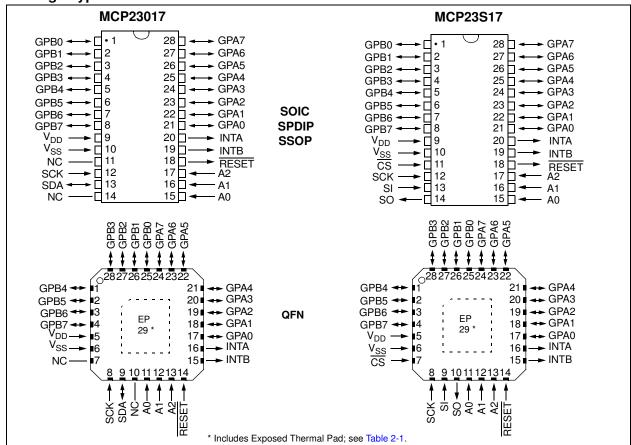
- 16-Bit Remote Bidirectional I/O Port:
  - I/O pins default to input
- High-Speed I<sup>2</sup>C Interface (MCP23017):
  - 100 kHz
  - 400 kHz
  - 1.7 MHz
- High-Speed SPI Interface (MCP23S17):
  - 10 MHz (maximum)
- Three Hardware Address Pins to Allow Up to Eight Devices On the Bus
- · Configurable Interrupt Output Pins:
  - Configurable as active-high, active-low or open-drain
- INTA and INTB Can Be Configured to Operate Independently or Together

- · Configurable Interrupt Source:
  - Interrupt-on-change from configured register defaults or pin changes
- Polarity Inversion Register to Configure the Polarity of the Input Port Data
- · External Reset Input
- Low Standby Current: 1 μA (max.)
- · Operating Voltage:
  - 1.8V to 5.5V @ -40°C to +85°C
  - 2.7V to 5.5V @ -40°C to +85°C
  - 4.5V to 5.5V @ -40°C to +125°C

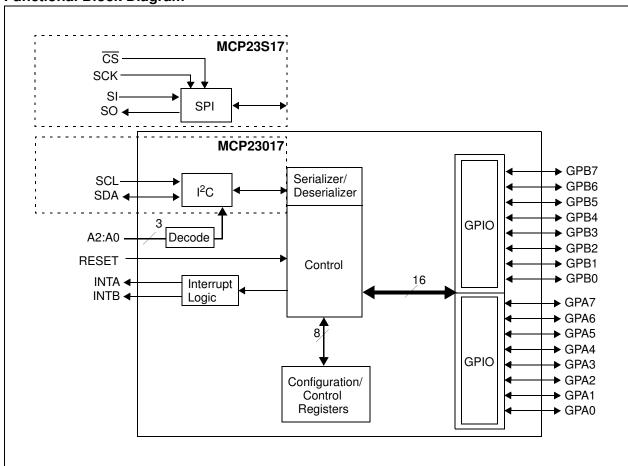
#### **Packages**

- 28-pin QFN, 6 x 6 mm Body
- · 28-pin SOIC, Wide, 7.50 mm Body
- · 28-pin SPDIP, 300 mil Body
- · 28-pin SSOP, 5.30 mm Body

#### **Package Types**



#### **Functional Block Diagram**



#### 1.0 ELECTRICAL CHARACTERISTICS

#### **Absolute Maximum Ratings †**

| Ambient temperature under bias  | 40°C to +125°C                   |
|---|----------------------------------|
| Storage temperature   | 65°C to +150°C                   |
| Voltage on V <sub>DD</sub> with respect to V <sub>SS</sub>                          | 0.3V to +5.5V                    |
| Voltage on all other pins with respect to V <sub>SS</sub> (except V <sub>DD</sub> ) | 0.6V to (V <sub>DD</sub> + 0.6V) |
| Total power dissipation   | 700 mW                           |
| Maximum current out of V <sub>SS</sub> pin  | 150 mA                           |
| Maximum current into V <sub>DD</sub> pin  | 125 mA                           |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{DD}$ )                       | ±20 mA                           |
| Output clamp current, lok $(V_O < 0 \text{ or } V_O > V_{DD})$                      | ±20 mA                           |
| Maximum output current sunk by any output pin                                       | 25 mA                            |
| Maximum output current sourced by any output pin                                    | 25 mA                            |
| ESD protection on all pins (HBM:MM)   | 4 kV:400V                        |

**<sup>†</sup> Notice**: Stresses above those listed under "Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

#### 1.1 DC Characteristics

TABLE 1-1: DC CHARACTERISTICS

|               | al Specifications: Unless of                           |                   |                       |                     |                      |       |  |
|---------------|--|-------------------|-----------------------|---------------------|----------------------|-------|--|
| Param.<br>No. | Characteristic   | Sym.              | Min.                  | Typ. <sup>(1)</sup> | Max.                 | Units | Conditions   |
| D001          | Supply Voltage   | $V_{DD}$          | 1.8                   |                     | 5.5                  | ٧     |  |
| D002          | V <sub>DD</sub> Start Voltage to ensure Power-on Reset | V <sub>POR</sub>  | _                     | $V_{SS}$            | _                    | V     |  |
| D003          | V <sub>DD</sub> Rise Rate to ensure<br>Power-on Reset  | SV <sub>DD</sub>  | 0.05                  | _                   | _                    | V/ms  | Design guidance only.<br>Not tested.   |
| D004          | Supply Current   | I <sub>DD</sub>   | _                     |                     | 1                    | mA    | SCL/SCK = 1 MHz  |
| D005          | Standby current  | I <sub>DDS8</sub> | _                     |                     | 1                    | μΑ    | $-40$ °C $\leq T_A \leq +85$ °C  |
|               |  |                   | _                     |                     | 3                    | μΑ    | $4.5V \le V_{DD} \le 5.5V +85^{\circ}C \le T_{A} \le +125^{\circ}C$ (Note 1) |
| Input Lo      | w Voltage  |                   |                       |                     |                      |       |  |
| D030          | A0, A1, A2 (TTL buffer)                                | $V_{IL}$          | V <sub>SS</sub>       |                     | 0.15 V <sub>DD</sub> | ٧     |  |
| D031          | CS, GPIO, SCL/SCK,<br>SDA, RESET<br>(Schmitt Trigger)  | V <sub>IL</sub>   | V <sub>SS</sub>       | _                   | 0.2 V <sub>DD</sub>  | V     |  |
| Input Hi      | gh Voltage   |                   |                       |                     |                      |       |  |
| D040          | A0, A1, A2 (TTL buffer)                                | V <sub>IH</sub>   | 0.25 VDD + 0.8        | _                   | V <sub>DD</sub>      | V     |  |
| D041          | CS, GPIO, SCL/SCK,<br>SDA, RESET<br>(Schmitt Trigger)  | V <sub>IH</sub>   | 0.8 VDD               |                     | V <sub>DD</sub>      | V     | For entire V <sub>DD</sub> range   |
| Input Le      | akage Current  |                   |                       |                     |                      |       |  |
| D060          | I/O port pins  | I <sub>IL</sub>   | _                     | _                   | ±1                   | μΑ    | $V_{SS} \le V_{PIN} \le V_{DD}$  |
| Output l      | Leakage Current  |                   |                       |                     |                      |       |  |
| D065          | I/O port pins  | I <sub>LO</sub>   | _                     | _                   | ±1                   | μΑ    | $V_{SS} \le V_{PIN} \le V_{DD}$  |
| D070          | GPIO weak pull-up current                              | I <sub>PU</sub>   | 40                    | 75                  | 115                  | μΑ    | $V_{DD} = 5V$<br>GP pins = $V_{SS}$  |
| Output l      | Low-Voltage  |                   |                       |                     |                      |       |  |
| D080          | GPIO   | V <sub>OL</sub>   | _                     | _                   | 0.6                  | V     | $I_{OL} = 8.0 \text{ mA}$<br>$V_{DD} = 4.5 \text{V}$                         |
|               | INT  | V <sub>OL</sub>   | _                     | _                   | 0.6                  | V     | $I_{OL} = 1.6 \text{ mA}$<br>$V_{DD} = 4.5 \text{V}$                         |
|               | SO, SDA  | V <sub>OL</sub>   | _                     | _                   | 0.6                  | V     | I <sub>OL</sub> = 3.0 mA<br>V <sub>DD</sub> = 1.8V                           |
|               | SDA  | V <sub>OL</sub>   | _                     | _                   | 0.8                  | V     | I <sub>OL</sub> = 3.0 mA<br>V <sub>DD</sub> = 4.5V                           |
| Output l      | High-Voltage   |                   |                       |                     |                      |       |  |
| D090          | GPIO, INT, SO  | V <sub>OH</sub>   | V <sub>DD</sub> – 0.7 | _                   | _                    | V     | I <sub>OH</sub> = -3.0 mA<br>V <sub>DD</sub> = 4.5V                          |
|               |  |                   | V <sub>DD</sub> – 0.7 | _                   | _                    |       | I <sub>OH</sub> = -400 μA<br>V <sub>DD</sub> = 1.8V                          |
| Capaciti      | ve Loading Specs on Out                                | put Pins          |                       |                     |                      |       |  |
| D101          | GPIO, SO, INT  | C <sub>IO</sub>   | _                     | _                   | 50                   | pF    |  |
| D102          | SDA  | C <sub>B</sub>    |                       |                     | 400                  | pF    |  |

**Note 1:** This parameter is characterized, not 100% tested.

#### 1.2 AC Characteristics

FIGURE 1-1: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS

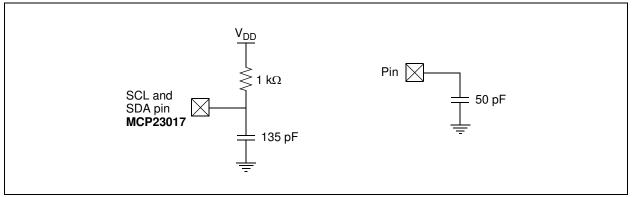


FIGURE 1-2: RESET AND DEVICE RESET TIMER TIMING

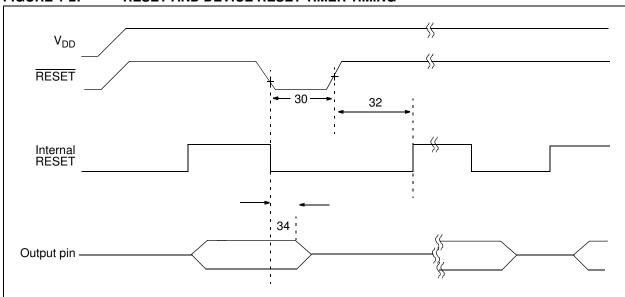


TABLE 1-2: DEVICE RESET SPECIFICATIONS

| AC Cha        | <b>AC Characteristics:</b> Unless otherwise noted, $1.8V \le V_{DD} \le 5.5V$ at $-40^{\circ}C \le T_{A} \le +125^{\circ}C$ |                   |      |                     |      |       |                        |  |  |  |  |
|---------------|---|-------------------|------|---------------------|------|-------|------------------------|--|--|--|--|
| Param.<br>No. | Characteristic  | Sym.              | Min. | Typ. <sup>(1)</sup> | Max. | Units | Conditions             |  |  |  |  |
| 30            | RESET Pulse Width (Low)   | T <sub>RSTL</sub> | 1    | _                   | _    | μѕ    |                        |  |  |  |  |
| 32            | Device Active After Reset high  | T <sub>HLD</sub>  | _    | 0                   | _    | ns    | V <sub>DD</sub> = 5.0V |  |  |  |  |
| 34            | Output High-Impedance<br>From RESET Low   | T <sub>IOZ</sub>  | _    | _                   | 1    | μs    |                        |  |  |  |  |

**Note 1:** This parameter is characterized, not 100% tested.

FIGURE 1-3: I<sup>2</sup>C BUS START/STOP BITS TIMING

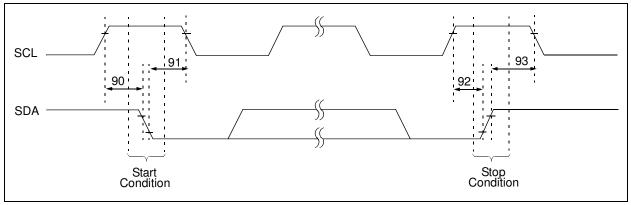


FIGURE 1-4: I<sup>2</sup>C BUS DATA TIMING

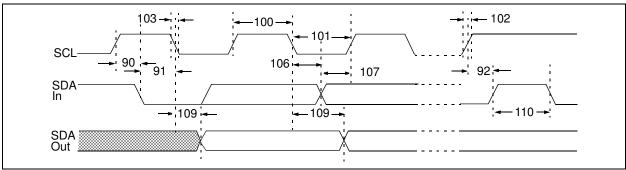


TABLE 1-3: I<sup>2</sup>C BUS DATA REQUIREMENTS

**I**<sup>2</sup>C Interface AC Characteristics: Unless otherwise noted, 1.8V  $\leq$  V<sub>DD</sub>  $\leq$  5.5V at -40°C  $\leq$  T<sub>A</sub>  $\leq$  +125°C, R<sub>PU</sub> (SCL, SDA) = 1 kΩ, C<sub>L</sub> (SCL, SDA) = 135 pF

| Param.<br>No. | Characteristic         | Sym.                          | Min.                                   | Тур. | Max. | Units | Conditions  |  |
|---------------|------------------------|-------------------------------|--|------|------|-------|-------------|--|
| 100           | Clock High Time:       | T <sub>HIGH</sub>             |  |      |      |       |             |  |
|               | 100 kHz mode           |                               | 4.0                                    | _    | _    | μs    | 1.8V – 5.5V |  |
|               | 400 kHz mode           |                               | 0.6                                    | _    | _    | μs    | 2.7V - 5.5V |  |
|               | 1.7 MHz mode           |                               | 0.12                                   | _    | _    | μs    | 4.5V – 5.5V |  |
| 101           | Clock Low Time:        | $T_{LOW}$                     |  |      |      |       |             |  |
|               | 100 kHz mode           |                               | 4.7                                    | _    | _    | μs    | 1.8V – 5.5V |  |
|               | 400 kHz mode           |                               | 1.3                                    | _    | _    | μs    | 2.7V - 5.5V |  |
|               | 1.7 MHz mode           |                               | 0.32                                   | _    | _    | μs    | 4.5V – 5.5V |  |
| 102           | SDA and SCL Rise Time: | T <sub>R</sub> <sup>(1)</sup> |  |      |      |       |             |  |
|               | 100 kHz mode           |                               | _                                      | _    | 1000 | ns    | 1.8V – 5.5V |  |
|               | 400 kHz mode           |                               | 20 + 0.1 C <sub>B</sub> <sup>(2)</sup> | _    | 300  | ns    | 2.7V - 5.5V |  |
|               | 1.7 MHz mode           |                               | 20                                     | _    | 160  | ns    | 4.5V – 5.5V |  |
| 103           | SDA and SCL Fall Time: | T <sub>F</sub> (1)            |  |      |      |       |             |  |
|               | 100 kHz mode           |                               | _                                      | _    | 300  | ns    | 1.8V – 5.5V |  |
|               | 400 kHz mode           |                               | 20 + 0.1 C <sub>B</sub> <sup>(2)</sup> |      | 300  | ns    | 2.7V - 5.5V |  |
|               | 1.7 MHz mode           |                               | 20                                     | _    | 80   | ns    | 4.5V – 5.5V |  |

**Note 1:** This parameter is characterized, not 100% tested.

2:  $C_B$  is specified to be from 10 to 400 pF.

TABLE 1-3: I<sup>2</sup>C BUS DATA REQUIREMENTS (CONTINUED)

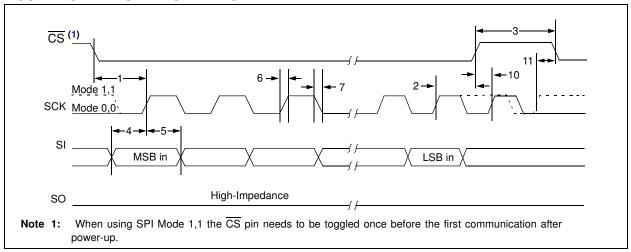
**I**<sup>2</sup>C Interface AC Characteristics: Unless otherwise noted,  $1.8V \le V_{DD} \le 5.5V$  at  $-40^{\circ}C \le T_{A} \le +125^{\circ}C$ ,  $R_{PU}$  (SCL, SDA) = 1 kΩ,  $C_{L}$  (SCL, SDA) = 135 pF

| Param.<br>No. | Characteristic                                | Sym.                | Min. | Тур. | Max. | Units | Conditions            |
|---------------|---|---------------------|------|------|------|-------|-----------------------|
| 90            | START Condition Setup Time:                   | T <sub>SU:STA</sub> |      |      |      |       |                       |
|               | 100 kHz mode                                  |                     | 4.7  | _    | —    | μs    | 1.8V – 5.5V           |
|               | 400 kHz mode                                  |                     | 0.6  | _    | _    | μs    | 2.7V - 5.5V           |
|               | 1.7 MHz mode                                  |                     | 0.16 | _    |      | μs    | 4.5V – 5.5V           |
| 91            | START Condition Hold Time:                    | T <sub>HD:STA</sub> |      |      |      |       |                       |
|               | 100 kHz mode                                  |                     | 4.0  | _    | —    | μs    | 1.8V – 5.5V           |
|               | 400 kHz mode                                  |                     | 0.6  | _    | _    | μs    | 2.7V - 5.5V           |
|               | 1.7 MHz mode                                  |                     | 0.16 | _    | —    | μs    | 4.5V – 5.5V           |
| 106           | Data Input Hold Time:                         | T <sub>HD:DAT</sub> |      |      |      |       |                       |
|               | 100 kHz mode                                  |                     | 0    | _    | 3.45 | μs    | 1.8V – 5.5V           |
|               | 400 kHz mode                                  |                     | 0    | _    | 0.9  | μs    | 2.7V - 5.5V           |
|               | 1.7 MHz mode                                  |                     | 0    | _    | 0.15 | μs    | 4.5V – 5.5V           |
| 107           | Data Input Setup Time:                        | T <sub>SU:DAT</sub> |      |      |      |       |                       |
|               | 100 kHz mode                                  |                     | 250  | _    | _    | ns    | 1.8V – 5.5V           |
|               | 400 kHz mode                                  |                     | 100  | _    | _    | ns    | 2.7V - 5.5V           |
|               | 1.7 MHz mode                                  |                     | 0.01 | _    | _    | μs    | 4.5V – 5.5V           |
| 92            | Stop Condition Setup Time:                    | T <sub>SU:STO</sub> |      |      |      |       |                       |
|               | 100 kHz mode                                  |                     | 4.0  | _    | _    | μs    | 1.8V - 5.5V           |
|               | 400 kHz mode                                  |                     | 0.6  | _    | _    | μs    | 2.7V - 5.5V           |
|               | 1.7 MHz mode                                  |                     | 0.16 | _    | —    | μs    | 4.5V-5.5V             |
| 109           | Output Valid From Clock:                      | T <sub>AA</sub>     |      |      |      |       |                       |
|               | 100 kHz mode                                  |                     |      | _    | 3.45 | μs    | 1.8V – 5.5V           |
|               | 400 kHz mode                                  |                     |      | _    | 0.9  | μs    | 2.7V - 5.5V           |
|               | 1.7 MHz mode                                  |                     |      | _    | 0.18 | μs    | 4.5V – 5.5V           |
| 110           | Bus Free Time:                                | T <sub>BUF</sub>    |      |      |      |       |                       |
|               | 100 kHz mode                                  |                     | 4.7  | _    | —    | μs    | 1.8V – 5.5V           |
|               | 400 kHz mode                                  |                     | 1.3  | _    | _    | μs    | 2.7V - 5.5V           |
|               | 1.7 MHz mode                                  |                     | N/A  | _    | N/A  | μs    | 4.5V – 5.5V           |
| 111           | Bus Capacitive Loading:                       | C <sub>B</sub>      |      |      |      |       |                       |
|               | 100 kHz and 400 kHz                           |                     |      | _    | 400  | рF    | Note 1                |
|               | 1.7 MHz                                       |                     |      | _    | 100  | рF    | Note 1                |
| 112           | Input Filter Spike Suppression (SDA and SCL): | T <sub>SP</sub>     |      |      |      |       |                       |
|               | 100 kHz and 400 kHz                           |                     |      |      | 50   | ns    |                       |
|               | 1.7 MHz                                       |                     |      | _    | 10   | ns    | Spike suppression off |

**Note 1:** This parameter is characterized, not 100% tested.

<sup>2:</sup>  $C_B$  is specified to be from 10 to 400 pF.

#### FIGURE 1-5: SPI INPUT TIMING



#### FIGURE 1-6: SPI OUTPUT TIMING

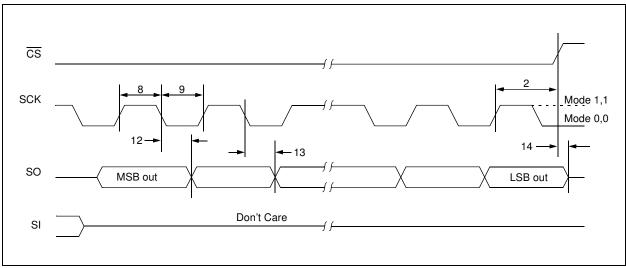


TABLE 1-4: SPI INTERFACE REQUIREMENTS

| <b>SPI Interface AC Characteristics:</b> Unless otherwise noted, $1.8V \le V_{DD} \le 5.5V$ at $-40^{\circ}C \le T_{A} \le +125^{\circ}C$ |                 |                  |      |      |      |       |             |  |  |
|---|-----------------|------------------|------|------|------|-------|-------------|--|--|
| Param.<br>No.   | Characteristic  | Sym.             | Min. | Тур. | Max. | Units | Conditions  |  |  |
| _   | Clock Frequency | F <sub>CLK</sub> | _    |      | 5    | MHz   | 1.8V – 5.5V |  |  |
|   |                 |                  | _    |      | 10   | MHz   | 2.7V – 5.5V |  |  |
|   |                 |                  |      |      | 10   | MHz   | 4.5V – 5.5V |  |  |
| 1   | CS Setup Time   | $T_{CSS}$        | 50   |      | —    | ns    |             |  |  |
| 2   | CS Hold Time    | T <sub>CSH</sub> | 100  |      | _    | ns    | 1.8V – 5.5V |  |  |
|   |                 |                  | 50   | _    |      | ns    | 2.7V – 5.5V |  |  |
| 3   | CS Disable Time | $T_{CSD}$        | 100  |      |      | ns    | 1.8V – 5.5V |  |  |
|   |                 |                  | 50   |      | _    | ns    | 2.7V - 5.5V |  |  |
| 4   | Data Setup Time | $T_{SU}$         | 20   | _    | _    | ns    | 1.8V – 5.5V |  |  |
|   |                 |                  | 10   | _    | _    | ns    | 2.7V - 5.5V |  |  |

**Note 1:** This parameter is characterized, not 100% tested.

TABLE 1-4: SPI INTERFACE REQUIREMENTS (CONTINUED)

| SPI Inter     | face AC Characteristics: Unle | ss otherwi       | se noted | , 1.8V ≤ | $V_{DD} \le 5$ | .5V at -4 | $0^{\circ}\text{C} \leq \text{T}_{\text{A}} \leq +125^{\circ}\text{C}$ |
|---------------|-------------------------------|------------------|----------|----------|----------------|-----------|--|
| Param.<br>No. | Characteristic                | Sym.             | Min.     | Тур.     | Max.           | Units     | Conditions   |
| 5             | Data Hold Time                | T <sub>HD</sub>  | 20       | _        | _              | ns        | 1.8V – 5.5V  |
|               |                               |                  | 10       | _        |                | ns        | 2.7V - 5.5V  |
| 6             | CLK Rise Time                 | $T_R$            |          |          | 2              | μs        | Note 1   |
| 7             | CLK Fall Time                 | T <sub>F</sub>   |          | _        | 2              | μs        | Note 1   |
| 8             | Clock High Time               | T <sub>HI</sub>  | 90       | _        |                | ns        | 1.8V – 5.5V  |
|               |                               |                  | 45       |          |                | ns        | 2.7V - 5.5V  |
| 9             | Clock Low Time                | T <sub>LO</sub>  | 90       |          |                | ns        | 1.8V – 5.5V  |
|               |                               |                  | 45       |          |                | ns        | 2.7V - 5.5V  |
| 10            | Clock Delay Time              | $T_{CLD}$        | 50       |          |                | ns        |  |
| 11            | Clock Enable Time             | T <sub>CLE</sub> | 50       | _        |                | ns        |  |
| 12            | Output Valid from Clock Low   | T <sub>V</sub>   | _        | _        | 90             | ns        | 1.8V – 5.5V  |
|               |                               |                  | _        | _        | 45             | ns        | 2.7V - 5.5V  |
| 13            | Output Hold Time              | T <sub>HO</sub>  | 0        | _        | _              | ns        |  |
| 14            | Output Disable Time           | $T_{DIS}$        | _        | _        | 100            | ns        |  |

**Note 1:** This parameter is characterized, not 100% tested.



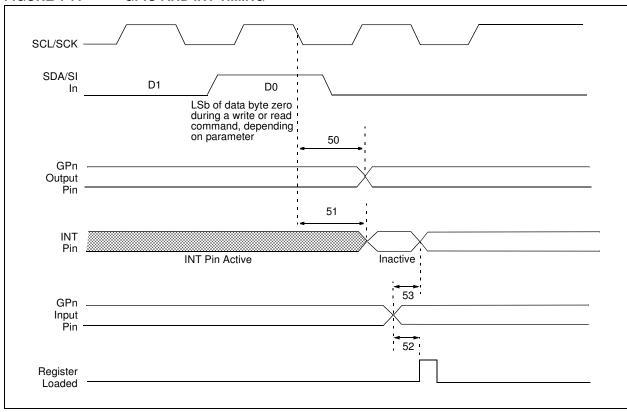


TABLE 1-5: GP AND INT PINS REQUIREMENTS

| GP and IN     | <b>GP and INT Pins AC Characteristics:</b> Unless otherwise noted, $1.8V \le V_{DD} \le 5.5V$ at $-40^{\circ}C \le T_{A} \le +125^{\circ}C$ |                     |   |   |     |    |        |  |  |  |  |
|---------------|---|---------------------|---|---|-----|----|--------|--|--|--|--|
| Param.<br>No. | Characteristic  | Conditions          |   |   |     |    |        |  |  |  |  |
| 50            | Serial Data to Output Valid   | T <sub>GPOV</sub>   | _ | _ | 500 | ns |        |  |  |  |  |
| 51            | Interrupt Pin Disable Time  | T <sub>INTD</sub>   | _ | _ | 600 | ns |        |  |  |  |  |
| 52            | GP Input Change to<br>Register Valid  | T <sub>GPIV</sub>   | _ | _ | 450 | ns |        |  |  |  |  |
| 53            | IOC Event to INT Active   | T <sub>GPINT</sub>  | _ | _ | 600 | ns |        |  |  |  |  |
|               | Glitch Filter on GP Pins  | T <sub>GLITCH</sub> | _ | _ | 150 | ns | Note 1 |  |  |  |  |

**Note 1:** This parameter is characterized, not 100% tested.

#### 2.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 2-1.

TABLE 2-1: PINOUT DESCRIPTION

| Pin<br>Name     | QFN | SOIC<br>SPDIP<br>SSOP | Pin<br>Type | Function   |
|-----------------|-----|-----------------------|-------------|--|
| GPB0            | 25  | 1                     | I/O         | Bidirectional I/O pin. Can be enabled for interrupt-on-change and/or internal weak pull-up resistor. |
| GPB1            | 26  | 2                     | I/O         | Bidirectional I/O pin. Can be enabled for interrupt-on-change and/or internal weak pull-up resistor. |
| GPB2            | 27  | 3                     | I/O         | Bidirectional I/O pin. Can be enabled for interrupt-on-change and/or internal weak pull-up resistor. |
| GPB3            | 28  | 4                     | I/O         | Bidirectional I/O pin. Can be enabled for interrupt-on-change and/or internal weak pull-up resistor. |
| GPB4            | 1   | 5                     | I/O         | Bidirectional I/O pin. Can be enabled for interrupt-on-change and/or internal weak pull-up resistor. |
| GPB5            | 2   | 6                     | I/O         | Bidirectional I/O pin. Can be enabled for interrupt-on-change and/or internal weak pull-up resistor. |
| GPB6            | 3   | 7                     | I/O         | Bidirectional I/O pin. Can be enabled for interrupt-on-change and/or internal weak pull-up resistor. |
| GPB7            | 4   | 8                     | I/O         | Bidirectional I/O pin. Can be enabled for interrupt-on-change and/or internal weak pull-up resistor. |
| $V_{DD}$        | 5   | 9                     | Р           | Power  |
| V <sub>SS</sub> | 6   | 10                    | Р           | Ground   |
| NC/CS           | 7   | 11                    | I           | NC (MCP23017)/Chip Select (MCP23S17)   |
| SCK             | 8   | 12                    | I           | Serial clock input   |
| SDA/SI          | 9   | 13                    | I/O         | Serial data I/O (MCP23017)/Serial data input (MCP23S17)  |
| NC/SO           | 10  | 14                    | 0           | NC (MCP23017)/Serial data out (MCP23S17)   |
| A0              | 11  | 15                    | I           | Hardware address pin. Must be externally biased.   |
| A1              | 12  | 16                    | I           | Hardware address pin. Must be externally biased.   |
| A2              | 13  | 17                    | I           | Hardware address pin. Must be externally biased.   |
| RESET           | 14  | 18                    | I           | Hardware reset. Must be externally biased.   |
| INTB            | 15  | 19                    | 0           | Interrupt output for PORTB. Can be configured as active-high, active-low or open-drain.              |
| INTA            | 16  | 20                    | 0           | Interrupt output for PORTA. Can be configured as active-high, active-low or open-drain.              |
| GPA0            | 17  | 21                    | I/O         | Bidirectional I/O pin. Can be enabled for interrupt-on-change and/or internal weak pull-up resistor. |
| GPA1            | 18  | 22                    | I/O         | Bidirectional I/O pin. Can be enabled for interrupt-on-change and/or internal weak pull-up resistor. |
| GPA2            | 19  | 23                    | I/O         | Bidirectional I/O pin. Can be enabled for interrupt-on-change and/or internal weak pull-up resistor. |
| GPA3            | 20  | 24                    | I/O         | Bidirectional I/O pin. Can be enabled for interrupt-on-change and/or internal weak pull-up resistor. |
| GPA4            | 21  | 25                    | I/O         | Bidirectional I/O pin. Can be enabled for interrupt-on-change and/or internal weak pull-up resistor. |
| GPA5            | 22  | 26                    | I/O         | Bidirectional I/O pin. Can be enabled for interrupt-on-change and/or internal weak pull-up resistor. |
| GPA6            | 23  | 27                    | I/O         | Bidirectional I/O pin. Can be enabled for interrupt-on-change and/or internal weak pull-up resistor. |
| GPA7            | 24  | 28                    | I/O         | Bidirectional I/O pin. Can be enabled for interrupt-on-change and/or internal weak pull-up resistor. |
| EP              | 29  | _                     | _           | Exposed Thermal Pad. Either connect to V <sub>SS</sub> , or leave unconnected.                       |

#### 3.0 DEVICE OVERVIEW

The MCP23017/MCP23S17 (MCP23X17) device family provides 16-bit, general purpose parallel I/O expansion for I<sup>2</sup>C bus or SPI applications. The two devices differ only in the serial interface:

- MCP23017 I<sup>2</sup>C interface
- MCP23S17 SPI interface

The MCP23X17 consists of multiple 8-bit configuration registers for input, output and polarity selection. The system master can enable the I/Os as either inputs or outputs by writing the I/O configuration bits (IODIRA/B). The data for each input or output is kept in the corresponding input or output register. The polarity of the Input Port register can be inverted with the Polarity Inversion register. All registers can be read by the system master.

The 16-bit I/O port functionally consists of two 8-bit ports (PORTA and PORTB). The MCP23X17 can be configured to operate in the 8-bit or 16-bit modes via IOCON.BANK.

There are two interrupt pins, INTA and INTB, that can be associated with their respective ports, or can be logically OR'ed together so that both pins will activate if either port causes an interrupt.

The interrupt output can be configured to activate under two conditions (mutually exclusive):

- When any input state differs from its corresponding Input Port register state. This is used to indicate to the system master that an input state has changed.
- 2. When an input state differs from a preconfigured register value (DEFVAL register).

The Interrupt Capture register captures port values at the time of the interrupt, thereby saving the condition that caused the interrupt.

The Power-on Reset (POR) sets the registers to their default values and initializes the device state machine.

The hardware address pins are used to determine the device address.

#### 3.1 Power-on Reset (POR)

The on-chip POR circuit holds the device in reset until  $V_{DD}$  has reached a high enough voltage to deactivate the POR circuit (i.e., release the device from reset). The maximum  $V_{DD}$  rise time is specified in **Section 1.0** "Electrical Characteristics".

When the device exits the POR condition (releases reset), device operating parameters (i.e., voltage, temperature, serial bus frequency, etc.) must be met to ensure proper operation.

#### 3.2 Serial Interface

This block handles the functionality of the  $I^2C$  (MCP23017) or SPI (MCP23S17) interface protocol. The MCP23X17 contains 22 individual registers (11 register pairs) that can be addressed through the Serial Interface block, as shown in Table 3-1.

TABLE 3-1: REGISTER ADDRESSES

| ı                         | 1   |  |
|---------------------------|---|--|
| Address<br>IOCON.BANK = 0 | Access to:  |  |
| 00h                       | IODIRA  |  |
| 01h                       | IODIRB  |  |
| 02h                       | IPOLA   |  |
| 03h                       | IPOLB   |  |
| 04h                       | GPINTENA  |  |
| 05h                       | GPINTENB  |  |
| 06h                       | DEFVALA   |  |
| 07h                       | DEFVALB   |  |
| 08h                       | INTCONA   |  |
| 09h                       | INTCONB   |  |
| 0Ah                       | IOCON   |  |
| 0Bh                       | IOCON   |  |
| 0Ch                       | GPPUA   |  |
| 0Dh                       | GPPUB   |  |
| 0Eh                       | INTFA   |  |
| 0Fh                       | INTFB   |  |
| 10h                       | INTCAPA   |  |
| 11h                       | INTCAPB   |  |
| 12h                       | GPIOA   |  |
| 13h                       | GPIOB   |  |
| 14h                       | OLATA   |  |
| 15h                       | OLATB   |  |
|                           | 00h 01h 02h 03h 04h 05h 06h 07h 08h 09h 0Ah 0Bh 0Ch 0Dh 0Eh 10h 11h 12h 13h |  |

### 3.2.1 BYTE MODE AND SEQUENTIAL MODE

The MCP23X17 family has the ability to operate in Byte mode or Sequential mode (IOCON.SEQOP).

Byte mode disables automatic Address Pointer incrementing. When operating in Byte mode, the MCP23X17 family does not increment its internal address counter after each byte during the data transfer. This gives the ability to continually access the same address by providing extra clocks (without additional control bytes). This is useful for polling the GPIO register for data changes or for continually writing to the output latches.

A special mode (Byte mode with IOCON.BANK = 0) causes the address pointer to toggle between associated A/B register pairs. For example, if the BANK bit is cleared and the Address Pointer is initially set to address 12h (GPIOA) or 13h (GPIOB), the pointer will toggle between GPIOA and GPIOB. Note that the Address Pointer can initially point to either address in the register pair.

**Sequential mode** enables automatic address pointer incrementing. When operating in Sequential mode, the MCP23X17 family increments its address counter after each byte during the data transfer. The Address Pointer automatically rolls over to address 00h after accessing the last register.

These two modes are not to be confused with single writes/reads and continuous writes/reads that are serial protocol sequences. For example, the device may be configured for Byte mode and the master may perform a continuous read. In this case, the MCP23X17 would not increment the Address Pointer and would repeatedly drive data from the same location.

#### 3.2.2 I<sup>2</sup>C INTERFACE

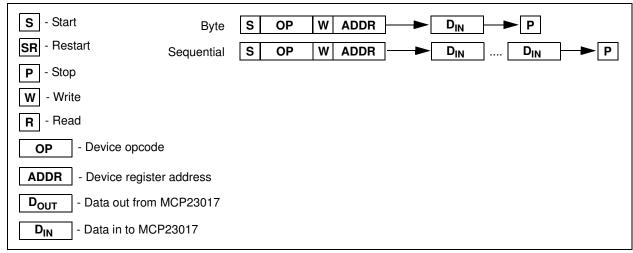
#### 3.2.2.1 I<sup>2</sup>C Write Operation

The I<sup>2</sup>C write operation includes the control byte and register address sequence, as shown in Figure 3-1. This sequence is followed by eight bits of data from the master and an Acknowledge (ACK) from the MCP23017. The operation is ended with a Stop (P) or Restart (SR) condition being generated by the master.

Data is written to the MCP23017 after every byte transfer. If a Stop or Restart condition is generated during a data transfer, the data will not be written to the MCP23017.

Both "byte writes" and "sequential writes" are supported by the MCP23017. If Sequential mode is enabled (IOCON, SEQOP = 0) (default), the MCP23017 increments its address counter after each ACK during the data transfer.

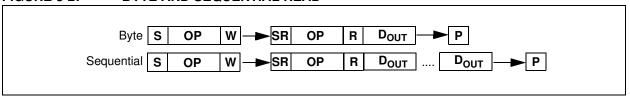
FIGURE 3-1: BYTE AND SEQUENTIAL WRITE



#### 3.2.2.2 I<sup>2</sup>C Read Operation

 $I^2C$  Read operations include the control byte sequence, as shown in Figure 3-2. This sequence is followed by another control byte (including the Start condition and ACK) with the R/W bit set (R/W = 1). The MCP23017 then transmits the data contained in the addressed register. The sequence is ended with the master generating a Stop or Restart condition.

FIGURE 3-2: BYTE AND SEQUENTIAL READ



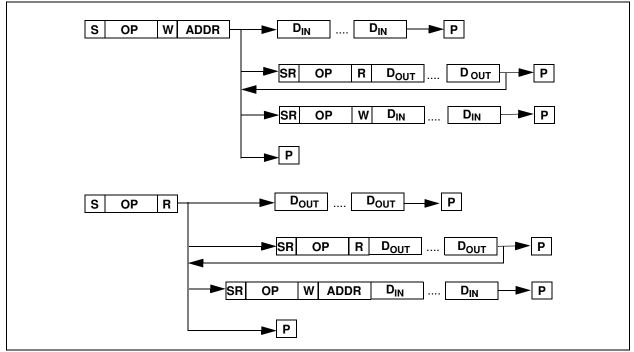
#### 3.2.2.3 I<sup>2</sup>C Sequential Write/Read

For sequential operations (Write or Read), instead of transmitting a Stop or Restart condition after the data transfer, the master clocks the next byte pointed to by the address pointer (see Section 3.2.1 "Byte Mode and Sequential Mode" for details regarding sequential operation control).

The sequence ends with the master sending a Stop or Restart condition.

The MCP23017 Address Pointer will roll over to address zero after reaching the last register address. Refer to Figure 3-3.

FIGURE 3-3: MCP23017 I<sup>2</sup>C DEVICE PROTOCOL



#### 3.2.3 SPI INTERFACE

#### 3.2.3.1 SPI Write Operation

The SPI write operation is started by lowering  $\overline{CS}$ . The Write command (slave address with R/W bit cleared) is then clocked into the device. The opcode is followed by an address and at least one data byte.

#### 3.2.3.2 SPI Read Operation

The SPI read operation is started by lowering  $\overline{CS}$ . The SPI read command (slave address with R/W bit set) is then clocked into the device. The opcode is followed by an address, with at least one data byte being clocked out of the device.

#### 3.2.3.3 SPI Seguential Write/Read

For sequential operations, instead of deselecting the device by raising  $\overline{CS}$ , the master clocks the next byte pointed to by the Address Pointer. (see Section 3.2.1 "Byte Mode and Sequential Mode" for details regarding sequential operation control).

The sequence ends by the raising of CS.

The MCP23S17 Address Pointer will roll over to address zero after reaching the last register address.

#### 3.3 Hardware Address Decoder

The hardware address pins are used to determine the device address. To address a device, the corresponding address bits in the control byte must match the pin state. The pins must be biased externally.

# 3.3.1 ADDRESSING I<sup>2</sup>C DEVICES (MCP23017)

The MCP23017 is a slave I<sup>2</sup>C interface device that supports 7-bit slave addressing, with the read/write bit filling out the control byte. The slave address contains

four fixed bits and three user-defined hardware address bits (pins A2, A1 and A0). Figure 3-4 shows the control byte format.

# 3.3.2 ADDRESSING SPI DEVICES (MCP23S17)

The MCP23S17 is a slave SPI device. The slave address contains four fixed bits and three user-defined hardware address bits (if enabled via IOCON.HAEN) (pins A2, A1 and A0) with the read/write bit filling out the control byte. Figure 3-5 shows the control byte format. The address pins should be externally biased even if disabled (IOCON.HAEN = 0).

FIGURE 3-4: I<sup>2</sup>C CONTROL BYTE FORMAT

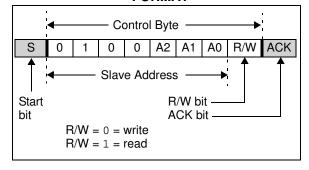


FIGURE 3-5: SPI CONTROL BYTE FORMAT

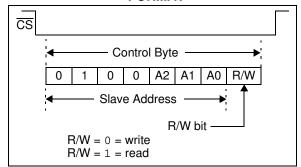
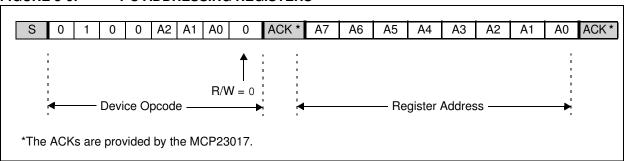
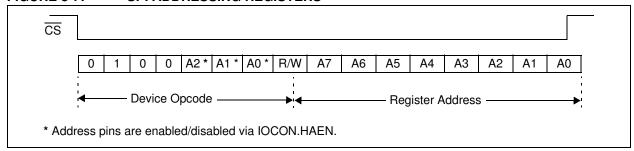


FIGURE 3-6: I<sup>2</sup>C ADDRESSING REGISTERS



#### FIGURE 3-7: SPI ADDRESSING REGISTERS



#### 3.4 GPIO Port

The GPIO module is a general purpose, 16-bit wide, bidirectional port that is functionally split into two 8-bit wide ports.

The GPIO module contains the data ports (GPIOn), internal pull-up resistors and the output latches (OLATn).

Reading the GPIOn register reads the value on the port. Reading the OLATn register only reads the latches, not the actual value on the port.

Writing to the GPIOn register actually causes a write to the latches (OLATn). Writing to the OLATn register forces the associated output drivers to drive to the level in OLATn. Pins configured as inputs turn off the associated output driver and put it in high-impedance.

TABLE 3-2: SUMMARY OF REGISTERS ASSOCIATED WITH THE GPIO PORTS (BANK = 1)

| Register<br>Name | Address<br>(hex) | bit 7  | bit 6  | bit 5  | bit 4  | bit 3  | bit 2  | bit 1  | bit 0  | POR/RST value |
|------------------|------------------|--------|--------|--------|--------|--------|--------|--------|--------|---------------|
| IODIRA           | 00               | 107    | IO6    | IO5    | IO4    | IO3    | IO2    | IO1    | IO0    | 1111 1111     |
| IPOLA            | 01               | IP7    | IP6    | IP5    | IP4    | IP3    | IP2    | IP1    | IP0    | 0000 0000     |
| GPINTENA         | 02               | GPINT7 | GPINT6 | GPINT5 | GPINT4 | GPINT3 | GPINT2 | GPINT1 | GPINT0 | 0000 0000     |
| GPPUA            | 06               | PU7    | PU6    | PU5    | PU4    | PU3    | PU2    | PU1    | PU0    | 0000 0000     |
| GPIOA            | 09               | GP7    | GP6    | GP5    | GP4    | GP3    | GP2    | GP1    | GP0    | 0000 0000     |
| OLATA            | 0A               | OL7    | OL6    | OL5    | OL4    | OL3    | OL2    | OL1    | OL0    | 0000 0000     |
| IODIRB           | 10               | 107    | IO6    | IO5    | IO4    | IO3    | 102    | IO1    | IO0    | 1111 1111     |
| IPOLB            | 11               | IP7    | IP6    | IP5    | IP4    | IP3    | IP2    | IP1    | IP0    | 0000 0000     |
| GPINTENB         | 12               | GPINT7 | GPINT6 | GPINT5 | GPINT4 | GPINT3 | GPINT2 | GPINT1 | GPINT0 | 0000 0000     |
| GPPUB            | 16               | PU7    | PU6    | PU5    | PU4    | PU3    | PU2    | PU1    | PU0    | 0000 0000     |
| GPIOB            | 19               | GP7    | GP6    | GP5    | GP4    | GP3    | GP2    | GP1    | GP0    | 0000 0000     |
| OLATB            | 1A               | OL7    | OL6    | OL5    | OL4    | OL3    | OL2    | OL1    | OL0    | 0000 0000     |

TABLE 3-3: SUMMARY OF REGISTERS ASSOCIATED WITH THE GPIO PORTS (BANK = 0)

| Register<br>Name | Address<br>(hex) | bit 7  | bit 6  | bit 5  | bit 4  | bit 3  | bit 2  | bit 1  | bit 0  | POR/RST<br>value |
|------------------|------------------|--------|--------|--------|--------|--------|--------|--------|--------|------------------|
| IODIRA           | 00               | 107    | IO6    | IO5    | IO4    | IO3    | IO2    | IO1    | IO0    | 1111 1111        |
| IODIRB           | 01               | 107    | IO6    | 105    | 104    | IO3    | 102    | IO1    | IO0    | 1111 1111        |
| IPOLA            | 02               | IP7    | IP6    | IP5    | IP4    | IP3    | IP2    | IP1    | IP0    | 0000 0000        |
| IPOLB            | 03               | IP7    | IP6    | IP5    | IP4    | IP3    | IP2    | IP1    | IP0    | 0000 0000        |
| GPINTENA         | 04               | GPINT7 | GPINT6 | GPINT5 | GPINT4 | GPINT3 | GPINT2 | GPINT1 | GPINT0 | 0000 0000        |
| GPINTENB         | 05               | GPINT7 | GPINT6 | GPINT5 | GPINT4 | GPINT3 | GPINT2 | GPINT1 | GPINT0 | 0000 0000        |
| GPPUA            | 0C               | PU7    | PU6    | PU5    | PU4    | PU3    | PU2    | PU1    | PU0    | 0000 0000        |
| GPPUB            | 0D               | PU7    | PU6    | PU5    | PU4    | PU3    | PU2    | PU1    | PU0    | 0000 0000        |
| GPIOA            | 12               | GP7    | GP6    | GP5    | GP4    | GP3    | GP2    | GP1    | GP0    | 0000 0000        |
| GPIOB            | 13               | GP7    | GP6    | GP5    | GP4    | GP3    | GP2    | GP1    | GP0    | 0000 0000        |
| OLATA            | 14               | OL7    | OL6    | OL5    | OL4    | OL3    | OL2    | OL1    | OL0    | 0000 0000        |
| OLATB            | 15               | OL7    | OL6    | OL5    | OL4    | OL3    | OL2    | OL1    | OL0    | 0000 0000        |

# 3.5 Configuration and Control Registers

There are 21 registers associated with the MCP23X17, as shown in Tables 3-4 and3-5. The two tables show the register mapping with the two BANK bit values. Ten registers are associated with PORTA and ten are

associated with PORTB. One register (IOCON) is shared between the two ports. The PORTA registers are identical to the PORTB registers, therefore, they will be referred to without differentiating between the port designation (i.e., they will not have the "A" or "B" designator assigned) in the register tables.

TABLE 3-4: CONTROL REGISTER SUMMARY (IOCON.BANK = 1)

| Register<br>Name | Address<br>(hex) | bit 7  | bit 6  | bit 5  | bit 4  | bit 3  | bit 2  | bit 1  | bit 0  | POR/RST value |
|------------------|------------------|--------|--------|--------|--------|--------|--------|--------|--------|---------------|
| IODIRA           | 00               | 107    | IO6    | IO5    | IO4    | IO3    | IO2    | IO1    | IO0    | 1111 1111     |
| IPOLA            | 01               | IP7    | IP6    | IP5    | IP4    | IP3    | IP2    | IP1    | IP0    | 0000 0000     |
| GPINTENA         | 02               | GPINT7 | GPINT6 | GPINT5 | GPINT4 | GPINT3 | GPINT2 | GPINT1 | GPINT0 | 0000 0000     |
| DEFVALA          | 03               | DEF7   | DEF6   | DEF5   | DEF4   | DEF3   | DEF2   | DEF1   | DEF0   | 0000 0000     |
| INTCONA          | 04               | IOC7   | IOC6   | IOC5   | IOC4   | IOC3   | IOC2   | IOC1   | IOC0   | 0000 0000     |
| IOCON            | 05               | BANK   | MIRROR | SEQOP  | DISSLW | HAEN   | ODR    | INTPOL | _      | 0000 0000     |
| GPPUA            | 06               | PU7    | PU6    | PU5    | PU4    | PU3    | PU2    | PU1    | PU0    | 0000 0000     |
| INTFA            | 07               | INT7   | INT6   | INT5   | INT4   | INT3   | INT2   | INT1   | INTO   | 0000 0000     |
| INTCAPA          | 08               | ICP7   | ICP6   | ICP5   | ICP4   | ICP3   | ICP2   | ICP1   | ICP0   | 0000 0000     |
| GPIOA            | 09               | GP7    | GP6    | GP5    | GP4    | GP3    | GP2    | GP1    | GP0    | 0000 0000     |
| OLATA            | 0A               | OL7    | OL6    | OL5    | OL4    | OL3    | OL2    | OL1    | OL0    | 0000 0000     |
| IODIRB           | 10               | 107    | IO6    | IO5    | IO4    | IO3    | IO2    | IO1    | IO0    | 1111 1111     |
| IPOLB            | 11               | IP7    | IP6    | IP5    | IP4    | IP3    | IP2    | IP1    | IP0    | 0000 0000     |
| GPINTENB         | 12               | GPINT7 | GPINT6 | GPINT5 | GPINT4 | GPINT3 | GPINT2 | GPINT1 | GPINT0 | 0000 0000     |
| DEFVALB          | 13               | DEF7   | DEF6   | DEF5   | DEF4   | DEF3   | DEF2   | DEF1   | DEF0   | 0000 0000     |
| INTCONB          | 14               | IOC7   | IOC6   | IOC5   | IOC4   | IOC3   | IOC2   | IOC1   | IOC0   | 0000 0000     |
| IOCON            | 15               | BANK   | MIRROR | SEQOP  | DISSLW | HAEN   | ODR    | INTPOL | _      | 0000 0000     |
| GPPUB            | 16               | PU7    | PU6    | PU5    | PU4    | PU3    | PU2    | PU1    | PU0    | 0000 0000     |
| INTFB            | 17               | INT7   | INT6   | INT5   | INT4   | INT3   | INT2   | INT1   | INTO   | 0000 0000     |
| INTCAPB          | 18               | ICP7   | ICP6   | ICP5   | ICP4   | ICP3   | ICP2   | ICP1   | ICP0   | 0000 0000     |
| GPIOB            | 19               | GP7    | GP6    | GP5    | GP4    | GP3    | GP2    | GP1    | GP0    | 0000 0000     |
| OLATB            | 1A               | OL7    | OL6    | OL5    | OL4    | OL3    | OL2    | OL1    | OL0    | 0000 0000     |

TABLE 3-5: CONTROL REGISTER SUMMARY (IOCON.BANK = 0)

| Register<br>Name | Address<br>(hex) | bit 7  | bit 6  | bit 5  | bit 4  | bit 3  | bit 2  | bit 1  | bit 0  | POR/RST<br>value |
|------------------|------------------|--------|--------|--------|--------|--------|--------|--------|--------|------------------|
| IODIRA           | 00               | 107    | IO6    | IO5    | IO4    | IO3    | IO2    | IO1    | IO0    | 1111 1111        |
| IODIRB           | 01               | 107    | IO6    | IO5    | IO4    | IO3    | 102    | IO1    | IO0    | 1111 1111        |
| IPOLA            | 02               | IP7    | IP6    | IP5    | IP4    | IP3    | IP2    | IP1    | IP0    | 0000 0000        |
| IPOLB            | 03               | IP7    | IP6    | IP5    | IP4    | IP3    | IP2    | IP1    | IP0    | 0000 0000        |
| GPINTENA         | 04               | GPINT7 | GPINT6 | GPINT5 | GPINT4 | GPINT3 | GPINT2 | GPINT1 | GPINT0 | 0000 0000        |
| GPINTENB         | 05               | GPINT7 | GPINT6 | GPINT5 | GPINT4 | GPINT3 | GPINT2 | GPINT1 | GPINT0 | 0000 0000        |
| DEFVALA          | 06               | DEF7   | DEF6   | DEF5   | DEF4   | DEF3   | DEF2   | DEF1   | DEF0   | 0000 0000        |
| DEFVALB          | 07               | DEF7   | DEF6   | DEF5   | DEF4   | DEF3   | DEF2   | DEF1   | DEF0   | 0000 0000        |
| INTCONA          | 08               | IOC7   | IOC6   | IOC5   | IOC4   | IOC3   | IOC2   | IOC1   | IOC0   | 0000 0000        |
| INTCONB          | 09               | IOC7   | IOC6   | IOC5   | IOC4   | IOC3   | IOC2   | IOC1   | IOC0   | 0000 0000        |
| IOCON            | 0A               | BANK   | MIRROR | SEQOP  | DISSLW | HAEN   | ODR    | INTPOL | _      | 0000 0000        |
| IOCON            | 0B               | BANK   | MIRROR | SEQOP  | DISSLW | HAEN   | ODR    | INTPOL | _      | 0000 0000        |
| GPPUA            | 0C               | PU7    | PU6    | PU5    | PU4    | PU3    | PU2    | PU1    | PU0    | 0000 0000        |
| GPPUB            | 0D               | PU7    | PU6    | PU5    | PU4    | PU3    | PU2    | PU1    | PU0    | 0000 0000        |

TABLE 3-5: CONTROL REGISTER SUMMARY (IOCON.BANK = 0) (CONTINUED)

| Register<br>Name | Address<br>(hex) | bit 7 | bit 6 | bit 5 | bit 4 | bit 3 | bit 2 | bit 1 | bit 0 | POR/RST value |
|------------------|------------------|-------|-------|-------|-------|-------|-------|-------|-------|---------------|
| INTFA            | 0E               | INT7  | INT6  | INT5  | INT4  | INT3  | INT2  | INT1  | INTO  | 0000 0000     |
| INTFB            | 0F               | INT7  | INT6  | INT5  | INT4  | INT3  | INT2  | INT1  | INTO  | 0000 0000     |
| INTCAPA          | 10               | ICP7  | ICP6  | ICP5  | ICP4  | ICP3  | ICP2  | ICP1  | ICP0  | 0000 0000     |
| INTCAPB          | 11               | ICP7  | ICP6  | ICP5  | ICP4  | ICP3  | ICP2  | ICP1  | ICP0  | 0000 0000     |
| GPIOA            | 12               | GP7   | GP6   | GP5   | GP4   | GP3   | GP2   | GP1   | GP0   | 0000 0000     |
| GPIOB            | 13               | GP7   | GP6   | GP5   | GP4   | GP3   | GP2   | GP1   | GP0   | 0000 0000     |
| OLATA            | 14               | OL7   | OL6   | OL5   | OL4   | OL3   | OL2   | OL1   | OL0   | 0000 0000     |
| OLATB            | 15               | OL7   | OL6   | OL5   | OL4   | OL3   | OL2   | OL1   | OL0   | 0000 0000     |

#### 3.5.1 I/O DIRECTION REGISTER

Controls the direction of the data I/O.

When a bit is set, the corresponding pin becomes an input. When a bit is clear, the corresponding pin becomes an output.

#### REGISTER 3-1: IODIR: I/O DIRECTION REGISTER (ADDR 0x00)

| R/W-1 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| 107   | IO6   | IO5   | IO4   | IO3   | IO2   | IO1   | IO0   |
| bit 7 |       |       |       |       |       |       | bit 0 |

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-0 **IO<7:0>:** Controls the direction of data I/O <7:0>

1 = Pin is configured as an input.

0 = Pin is configured as an output.

#### 3.5.2 INPUT POLARITY REGISTER

This register allows the user to configure the polarity on the corresponding GPIO port bits.

If a bit is set, the corresponding GPIO register bit will reflect the inverted value on the pin.

#### REGISTER 3-2: IPOL: INPUT POLARITY PORT REGISTER (ADDR 0x01)

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| IP7   | IP6   | IP5   | IP4   | IP3   | IP2   | IP1   | IP0   |
| bit 7 |       |       |       |       |       |       | bit 0 |

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-0 **IP<7:0>:** Controls the polarity inversion of the input pins <7:0>

1 = GPIO register bit reflects the opposite logic state of the input pin.

0 = GPIO register bit reflects the same logic state of the input pin.

## 3.5.3 INTERRUPT-ON-CHANGE CONTROL REGISTER

The GPINTEN register controls the interrupt-on-change feature for each pin.

If a bit is set, the corresponding pin is enabled for interrupt-on-change. The DEFVAL and INTCON registers must also be configured if any pins are enabled for interrupt-on-change.

#### REGISTER 3-3: GPINTEN: INTERRUPT-ON-CHANGE PINS (ADDR 0x02) (Note 1)

| R/W-0  |
|--------|--------|--------|--------|--------|--------|--------|--------|
| GPINT7 | GPINT6 | GPINT5 | GPINT4 | GPINT3 | GPINT2 | GPINT1 | GPINT0 |
| bit 7  |        |        |        |        |        |        | bit 0  |

#### Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-0 **GPINT<7:0>:** General purpose I/O interrupt-on-change bits <7:0>

1 = Enables GPIO input pin for interrupt-on-change event.

0 = Disables GPIO input pin for interrupt-on-change event.

Note 1: Refer to INTCON.

# 3.5.4 DEFAULT COMPARE REGISTER FOR INTERRUPT-ON-CHANGE

The default comparison value is configured in the DEFVAL register. If enabled (via GPINTEN and INTCON) to compare against the DEFVAL register, an opposite value on the associated pin will cause an interrupt to occur.

#### REGISTER 3-4: DEFVAL: DEFAULT VALUE REGISTER (ADDR 0x03)

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| DEF7  | DEF6  | DEF5  | DEF4  | DEF3  | DEF2  | DEF1  | DEF0  |
| bit 7 |       |       |       |       |       |       | bit 0 |

#### Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-0 **DEF<7:0>:** Sets the compare value for pins configured for interrupt-on-change from defaults <7:0> (Note 1)

If the associated pin level is the opposite from the register bit, an interrupt occurs. (Note 2)

Note 1: Refer to INTCON.

2: Refer to INTCON and GPINTEN.

#### 3.5.5 INTERRUPT CONTROL REGISTER

The INTCON register controls how the associated pin value is compared for the interrupt-on-change feature. If a bit is set, the corresponding I/O pin is compared against the associated bit in the DEFVAL register. If a bit value is clear, the corresponding I/O pin is compared against the previous value.

#### REGISTER 3-5: INTCON: INTERRUPT-ON-CHANGE CONTROL REGISTER (ADDR 0x04) (Note 1)

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| IOC7  | IOC6  | IOC5  | IOC4  | IOC3  | IOC2  | IOC1  | IOC0  |
| bit 7 |       |       |       |       |       |       | bit 0 |

| Legend:           |                  |                             |                    |
|-------------------|------------------|-----------------------------|--------------------|
| R = Readable bit  | W = Writable bit | U = Unimplemented bit, read | as '0'             |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared        | x = Bit is unknown |

bit 7-0 **IOC<7:0>:** Controls how the associated pin value is compared for interrupt-on-change <7:0>

- 1 = Pin value is compared against the associated bit in the DEFVAL register.
- 0 = Pin value is compared against the previous pin value.

Note 1: Refer to INTCON and GPINTEN.

#### 3.5.6 CONFIGURATION REGISTER

The IOCON register contains several bits for configuring the device:

The BANK bit changes how the registers are mapped (see Tables 3-4 and 3-5 for more details).

- If BANK = 1, the registers associated with each port are segregated. Registers associated with PORTA are mapped from address 00h - 0Ah and registers associated with PORTB are mapped from 10h - 1Ah.
- If BANK = 0, the A/B registers are paired. For example, IODIRA is mapped to address 00h and IODIRB is mapped to the next address (address 01h). The mapping for all registers is from 00h -15h.

It is important to take care when changing the BANK bit as the address mapping changes after the byte is clocked into the device. The address pointer may point to an invalid location after the bit is modified.

For example, if the device is configured to automatically increment its internal Address Pointer, the following scenario would occur:

- BANK = 0
- Write 80h to address 0Ah (IOCON) to set the BANK bit
- Once the write completes, the internal address now points to 0Bh which is an invalid address when the BANK bit is set.

For this reason, when changing the BANK bit, it is advised to only perform byte writes to this register.

The **MIRROR** bit controls how the INTA and INTB pins function with respect to each other.

- When MIRROR = 1, the INTn pins are functionally OR'ed so that an interrupt on either port will cause both pins to activate.
- When MIRROR = 0, the INT pins are separated. Interrupt conditions on a port will cause its respective INT pin to activate.

The Sequential Operation (**SEQOP**) controls the incrementing function of the Address Pointer. If the address pointer is disabled, the Address Pointer does not automatically increment after each byte is clocked during a serial transfer. This feature is useful when it is desired to continuously poll (read) or modify (write) a register.

The Slew Rate (**DISSLW**) bit controls the slew rate function on the SDA pin. If enabled, the SDA slew rate will be controlled when driving from a high to low.

The Hardware Address Enable (**HAEN**) bit enables/disables hardware addressing on the MCP23S17 only. The address pins (A2, A1 and A0) must be externally biased, regardless of the HAEN bit value.

If enabled (HAEN = 1), the device's hardware address matches the address pins.

If disabled (HAEN = 0), the device's hardware address is A2 = A1 = A0 = 0.

The Open-Drain (**ODR**) control bit enables/disables the INT pin for open-drain configuration. Setting this bit overrides the INTPOL bit.

Legend:

bit 0

The Interrupt Polarity (INTPOL) sets the polarity of the INT pin. This bit is functional only when the ODR bit is cleared, configuring the INT pin as active push-pull.

#### REGISTER 3-6: IOCON: I/O EXPANDER CONFIGURATION REGISTER (ADDR 0x05)

| R/W-0 | R/W-0  | R/W-0 | R/W-0  | R/W-0 | R/W-0 | R/W-0  | U-0   |
|-------|--------|-------|--------|-------|-------|--------|-------|
| BANK  | MIRROR | SEQOP | DISSLW | HAEN  | ODR   | INTPOL | _     |
| bit 7 |        |       |        |       |       |        | bit 0 |

| 5               |                        | 147 147 1 1 1 1 1 1                                      | 11 11 2 1 2 1 2 1 2 2                                       |                           |
|-----------------|------------------------|--|---|---------------------------|
| R = Readable l  | oit                    | W = Writable bit   | U = Unimplemented bit, read                                 | as '0'                    |
| -n = Value at P | OR                     | '1' = Bit is set   | '0' = Bit is cleared  | x = Bit is unknown        |
|                 |                        |  |   |                           |
| bit 7           | BANK: Contr            | ols how the registers are ac                             | dressed   |                           |
|                 | -                      | ters associated with each peters are in the same bank (a | ort are separated into different addresses are sequential). | banks.                    |
| bit 6           | MIRROR: IN             | Γ Pins Mirror bit  |   |                           |
|                 | 1 = The INT p          | oins are internally connected                            | J   |                           |
|                 | 0 = The INT p<br>PORTB | pins are not connected. INTA                             | A is associated with PORTA an                               | d INTB is associated with |
| bit 5           | SEQOP: Seq             | uential Operation mode bit                               |   |                           |
|                 | 1 = Sequenti           | al operation disabled, addre                             | ess pointer does not increment                              |                           |
|                 | 0 = Sequenti           | al operation enabled, addre                              | ss pointer increments.                                      |                           |
| bit 4           | DISSLW: Sle            | w Rate control bit for SDA o                             | utput   |                           |
|                 | 1 = Slew rate          | e disabled   |   |                           |
|                 | 0 = Slew rate          | e enabled  |   |                           |
| bit 3           | <b>HAEN:</b> Hardy     | vare Address Enable bit ( <b>M</b>                       | CP23S17 only) (Note 1)                                      |                           |
|                 |                        | the MCP23S17 address pin                                 |   |                           |
|                 | 0 = Disables           | the MCP23S17 address pir                                 | is.   |                           |
| bit 2           | ODR: Configu           | ures the INT pin as an open                              | -drain output   |                           |
|                 | •                      | ain output (overrides the INT                            | •   |                           |
|                 | 0 = Active dr          | iver output (INTPOL bit sets                             | the polarity.)  |                           |
| bit 1           | INTPOL: This           | s bit sets the polarity of the I                         | NT output pin   |                           |
|                 | 1 = Active-high        |  |   |                           |
|                 | 0 = Active-lov         | W  |   |                           |

**Note 1:** Address pins are always enabled on the MCP23017.

Unimplemented: Read as '0'

### 3.5.7 PULL-UP RESISTOR CONFIGURATION REGISTER

The GPPU register controls the pull-up resistors for the port pins. If a bit is set and the corresponding pin is configured as an input, the corresponding port pin is internally pulled up with a 100 k $\Omega$  resistor.

#### REGISTER 3-7: GPPU: GPIO PULL-UP RESISTOR REGISTER (ADDR 0x06)

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| PU7   | PU6   | PU5   | PU4   | PU3   | PU2   | PU1   | PU0   |
| bit 7 |       |       |       |       |       |       | bit 0 |

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-0 PU<7:0> Controls the weak pull-up resistors on each pin (when configured as an input)

1 = Pull-up enabled

0 = Pull-up disabled

#### 3.5.8 INTERRUPT FLAG REGISTER

The INTF register reflects the interrupt condition on the port pins of any pin that is enabled for interrupts via the GPINTEN register. A set bit indicates that the associated pin caused the interrupt.

This register is read-only. Writes to this register will be ignored.

#### REGISTER 3-8: INTF: INTERRUPT FLAG REGISTER (ADDR 0x07)

| R-0   | R-0  | R-0  | R-0  | R-0  | R-0  | R-0  | R-0   |
|-------|------|------|------|------|------|------|-------|
| INT7  | INT6 | INT5 | INT4 | INT3 | INT2 | INT1 | INT0  |
| bit 7 |      |      |      |      |      |      | bit 0 |

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-0 **INT<7:0>:** Reflects the interrupt condition on the port. It reflects the change only if interrupts are enabled per GPINTEN<7:0>.

1 = Pin caused interrupt.

0 = Interrupt not pending

#### 3.5.9 INTERRUPT CAPTURED REGISTER

The INTCAP register captures the GPIO port value at the time the interrupt occurred. The register is read-only and is updated only when an interrupt occurs. The register remains unchanged until the interrupt is cleared via a read of INTCAP or GPIO.

#### REGISTER 3-9: INTCAP: INTERRUPT CAPTURED VALUE FOR PORT REGISTER (ADDR 0x08)

| R-x   | R-x  | R-x  | R-x  | R-x  | R-x  | R-x  | R-x   |
|-------|------|------|------|------|------|------|-------|
| ICP7  | ICP6 | ICP5 | ICP4 | ICP3 | ICP2 | ICP1 | ICP0  |
| bit 7 |      |      |      |      |      |      | bit 0 |

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-0 ICP<7:0>: Reflects the logic level on the port pins at the time of interrupt due to pin change <7:0>

1 = Logic-high

0 = Logic-low

#### 3.5.10 PORT REGISTER

The GPIO register reflects the value on the port. Reading from this register reads the port. Writing to this register modifies the Output Latch (OLAT) register.

#### REGISTER 3-10: GPIO: GENERAL PURPOSE I/O PORT REGISTER (ADDR 0x09)

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| GP7   | GP6   | GP5   | GP4   | GP3   | GP2   | GP1   | GP0   |
| bit 7 |       |       |       |       |       |       | bit 0 |

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-0 **GP<7:0>:** Reflects the logic level on the pins <7:0>

1 = Logic-high

0 = Logic-low

#### 3.5.11 OUTPUT LATCH REGISTER (OLAT)

The OLAT register provides access to the output latches. A read from this register results in a read of the OLAT and not the port itself. A write to this register modifies the output latches that modifies the pins configured as outputs.

#### REGISTER 3-11: OLAT: OUTPUT LATCH REGISTER 0 (ADDR 0x0A)

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| OL7   | OL6   | OL5   | OL4   | OL3   | OL2   | OL1   | OL0   |
| bit 7 |       |       |       |       |       |       | bit 0 |

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-0 **OL<7:0>:** Reflects the logic level on the output latch <7:0>

1 = Logic-high
0 = Logic-low

#### 3.6 Interrupt Logic

If enabled, the MCP23X17 activates the INTn interrupt output when one of the port pins changes state or when a pin does not match the preconfigured default. Each pin is individually configurable as follows:

- Enable/disable interrupt via GPINTEN
- Can interrupt on either pin change or change from default as configured in DEFVAL

Both conditions are referred to as Interrupt-on-Change (IOC).

The interrupt control module uses the following registers/bits:

- IOCON.MIRROR controls if the two interrupt pins mirror each other
- GPINTEN Interrupt enable register
- INTCON controls the source for the IOC
- DEFVAL contains the register default for IOC operation

#### 3.6.1 INTA AND INTB

There are two interrupt pins: INTA and INTB. By default, INTA is associated with GPAn pins (PORTA) and INTB is associated with GPBn pins (PORTB). Each port has an independent signal which is cleared if its associated GPIO or INTCAP register is read.

#### 3.6.1.1 Mirroring the INT pins

Additionally, the INTn pins can be configured to mirror each other so that any interrupt will cause both pins to go active. This is controlled via IOCON.MIRROR.

If IOCON.MIRROR = 0, the internal signals are routed independently to the INTA and INTB pads.

If IOCON.MIRROR = 1, the internal signals are OR'ed together and routed to the INTn pads. In this case, the interrupt will only be cleared if the associated GPIO or INTCAP is read (see Table 3-6).

TABLE 3-6: INTERRUPT OPERATION (IOCON.MIRROR = 1)

| (100014.IMITITIOT1 = 1) |                      |                     |  |  |  |
|-------------------------|----------------------|---------------------|--|--|--|
| Interrupt<br>Condition  | Read PORTn (1)       | Interrupt<br>Result |  |  |  |
| GPIOA                   | PORTA                | Clear               |  |  |  |
| GPIOA                   | PORTB                | Unchanged           |  |  |  |
| GPIOB                   | PORTA                | Unchanged           |  |  |  |
| GFIOB                   | PORTB                | Clear               |  |  |  |
|                         | PORTA                | Unchanged           |  |  |  |
| GPIOA and               | PORTB                | Unchanged           |  |  |  |
| GPIOB                   | Both PORTA and PORTB | Clear               |  |  |  |

Note 1: PORTn = GPIOn or INTCAPn

#### 3.6.2 IOC FROM PIN CHANGE

If enabled, the MCP23X17 generates an interrupt if a mismatch condition exists between the current port value and the previous port value. Only IOC-enabled pins will be compared. Refer to Registers 3-3 and 3-5.

#### 3.6.3 IOC FROM REGISTER DEFAULT

If enabled, the MCP23X17 generates an interrupt if a mismatch occurs between the DEFVAL register and the port. Only IOC enabled pins are compared. Refer to Registers 3-3, 3-4 and 3-5.

#### 3.6.4 INTERRUPT OPERATION

The INTn interrupt output can be configured as active-low, active-high or open-drain via the IOCON register.

Only those pins that are configured as an input (IODIR register) with Interrupt-On-Change (IOC) enabled (IOINTEN register) can cause an interrupt. Pins defined as an output have no effect on the interrupt output pin.

Input change activity on a port input pin that is enabled for IOC generates an internal device interrupt and the device captures the value of the port and copies it into INTCAP. The interrupt remains active until the INTCAP or GPIO register is read. Writing to these registers does not affect the interrupt. The interrupt condition is cleared after the LSb of the data is clocked out during a read command of GPIO or INTCAP.

The first interrupt event causes the port contents to be copied into the INTCAP register. Subsequent interrupt conditions on the port will not cause an interrupt to occur as long as the interrupt is not cleared by a read of INTCAP or GPIO.

Note: The value in INTCAP can be lost if GPIO is read before INTCAP while another IOC is pending. After reading GPIO, the interrupt will clear and then set due to the pending IOC, causing the INTCAP register to update.

#### 3.6.5 INTERRUPT CONDITIONS

There are two possible configurations that cause interrupts (configured via INTCON):

- 1. Pins configured for **interrupt-on-pin change** will cause an interrupt to occur if a pin changes to the opposite state. The default state is reset after an interrupt occurs and after clearing the interrupt condition (i.e., after reading GPIO or INTCAP). For example, an interrupt occurs by an input changing from '1' to '0'. The new initial state for the pin is a logic '0' after the interrupt is cleared.
- Pins configured for interrupt-on-change from register value will cause an interrupt to occur if the corresponding input pin differs from the register bit. The interrupt condition will remain as long as the condition exists, regardless if the INTCAP or GPIO is read.

See Figures 3-8 and 3-9 for more information on interrupt operations.

FIGURE 3-8: INTERRUPT-ON-PIN CHANGE

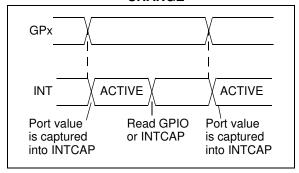
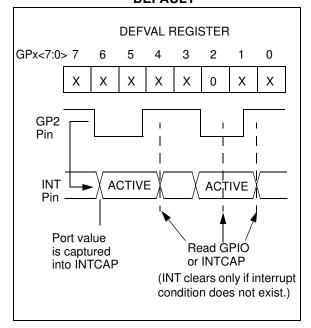


FIGURE 3-9: INTERRUPT-ON-CHANGE FROM REGISTER DEFAULT



#### 4.0 PACKAGING INFORMATION

#### 4.1 Package Marking Information

28-Lead QFN



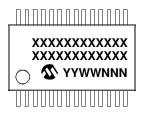
28-Lead SOIC



28-Lead SPDIP



28-Lead SSOP



#### Example:



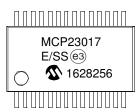
#### Example:



#### Example:



#### Example:

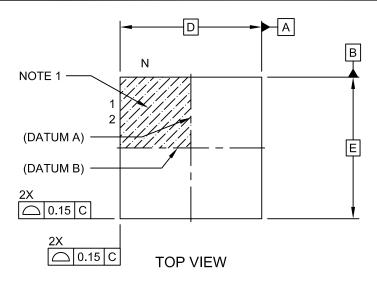


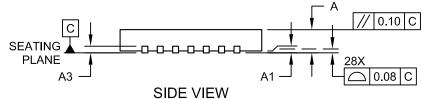
| \ | Y<br>YY<br>WW<br>NNN<br>@3 | Customer-specific information Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code Pb-free JEDEC designator for Matte Tin (Sn) This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package. |
|---|----------------------------|---|
|---|----------------------------|---|

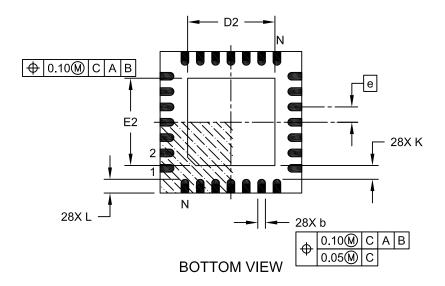
: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.

# 28-Lead Plastic Quad Flat, No Lead Package (ML) - 6x6 mm Body [QFN] With 0.55 mm Terminal Length

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



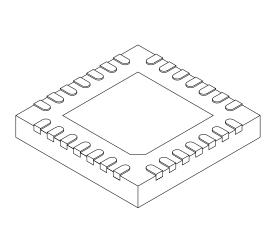




Microchip Technology Drawing C04-105C Sheet 1 of 2

# 28-Lead Plastic Quad Flat, No Lead Package (ML) - 6x6 mm Body [QFN] With 0.55 mm Terminal Length

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



|                         | Units  | М        | ILLIMETERS |      |
|-------------------------|--------|----------|------------|------|
| Dimension               | Limits | MIN      | NOM        | MAX  |
| Number of Pins          | N      |          | 28         |      |
| Pitch                   | е      |          | 0.65 BSC   |      |
| Overall Height          | Α      | 0.80     | 0.90       | 1.00 |
| Standoff                | A1     | 0.00     | 0.02       | 0.05 |
| Terminal Thickness      | А3     | 0.20 REF |            |      |
| Overall Width           | Е      | 6.00 BSC |            |      |
| Exposed Pad Width       | E2     | 3.65     | 3.70       | 4.20 |
| Overall Length          | D      |          | 6.00 BSC   |      |
| Exposed Pad Length      | D2     | 3.65     | 3.70       | 4.20 |
| Terminal Width          | b      | 0.23     | 0.30       | 0.35 |
| Terminal Length         | L      | 0.50     | 0.55       | 0.70 |
| Terminal-to-Exposed Pad | K      | 0.20     | -          | -    |

#### Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Package is saw singulated
- 3. Dimensioning and tolerancing per ASME Y14.5M.

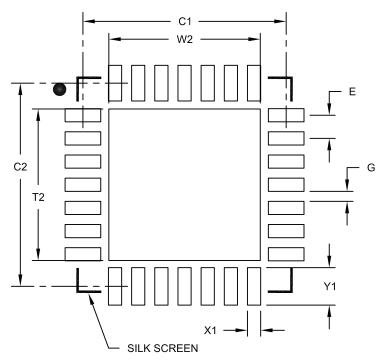
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-105C Sheet 2 of 2

# 28-Lead Plastic Quad Flat, No Lead Package (ML) – 6x6 mm Body [QFN] with 0.55 mm Contact Length

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

|                            | MILLIMETERS |          |      |      |  |
|----------------------------|-------------|----------|------|------|--|
| Dimension                  | MIN         | NOM      | MAX  |      |  |
| Contact Pitch E            |             | 0.65 BSC |      |      |  |
| Optional Center Pad Width  | W2          |          |      | 4.25 |  |
| Optional Center Pad Length | T2          |          |      | 4.25 |  |
| Contact Pad Spacing        | C1          |          | 5.70 |      |  |
| Contact Pad Spacing        | C2          |          | 5.70 |      |  |
| Contact Pad Width (X28)    | X1          |          |      | 0.37 |  |
| Contact Pad Length (X28)   | Y1          |          |      | 1.00 |  |
| Distance Between Pads      | G           | 0.20     |      |      |  |

#### Notes:

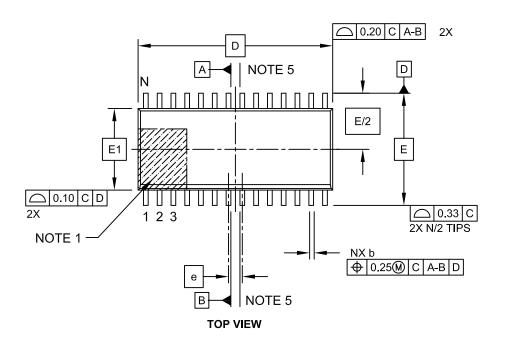
1. Dimensioning and tolerancing per ASME Y14.5M

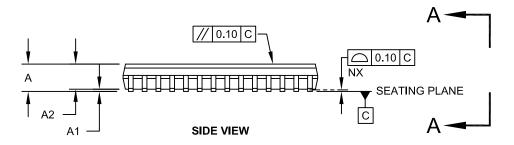
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

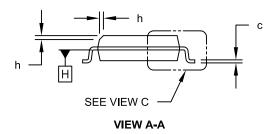
Microchip Technology Drawing No. C04-2105A

#### 28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

**Solution** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



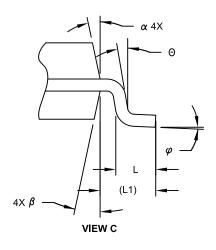


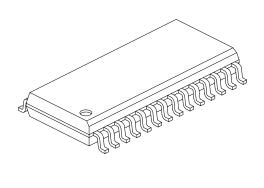


Microchip Technology Drawing C04-052C Sheet 1 of 2

#### 28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging





|                          | MILLIMETERS |           |          |      |  |
|--------------------------|-------------|-----------|----------|------|--|
| Dimension                | MIN         | NOM       | MAX      |      |  |
| Number of Pins           | N           |           | 28       |      |  |
| Pitch                    | е           |           | 1.27 BSC |      |  |
| Overall Height           | Α           | ı         | -        | 2.65 |  |
| Molded Package Thickness | A2          | 2.05      | -        | -    |  |
| Standoff §               | A1          | 0.10      | -        | 0.30 |  |
| Overall Width            | E           | 10.30 BSC |          |      |  |
| Molded Package Width     | E1          | 7.50 BSC  |          |      |  |
| Overall Length           | D           | 17.90 BSC |          |      |  |
| Chamfer (Optional)       | h           | 0.25      | -        | 0.75 |  |
| Foot Length              | L           | 0.40      | -        | 1.27 |  |
| Footprint                | L1          |           | 1.40 REF |      |  |
| Lead Angle               | Θ           | 0°        | -        | -    |  |
| Foot Angle               | φ           | 0°        | -        | 8°   |  |
| Lead Thickness           | С           | 0.18      | -        | 0.33 |  |
| Lead Width               | b           | 0.31      | -        | 0.51 |  |
| Mold Draft Angle Top     | α           | 5°        | -        | 15°  |  |
| Mold Draft Angle Bottom  | β           | 5°        | -        | 15°  |  |

#### Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. § Significant Characteristic
- Dimension D does not include mold flash, protrusions or gate burrs, which shall not exceed 0.15 mm per end. Dimension E1 does not include interlead flash or protrusion, which shall not exceed 0.25 mm per side.
- 4. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

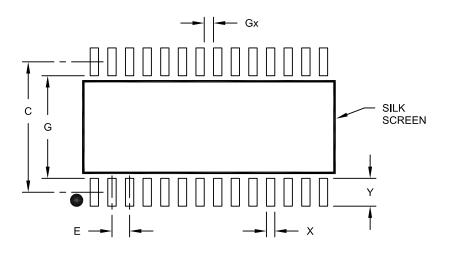
REF: Reference Dimension, usually without tolerance, for information purposes only.

5. Datums A & B to be determined at Datum H.

Microchip Technology Drawing C04-052C Sheet 2 of 2

#### 28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



#### RECOMMENDED LAND PATTERN

|                          | MILLIMETERS |          |      |      |
|--------------------------|-------------|----------|------|------|
| Dimension                | MIN         | NOM      | MAX  |      |
| Contact Pitch            | Е           | 1.27 BSC |      |      |
| Contact Pad Spacing      | С           |          | 9.40 |      |
| Contact Pad Width (X28)  | Х           |          |      | 0.60 |
| Contact Pad Length (X28) | Υ           |          |      | 2.00 |
| Distance Between Pads    | Gx          | 0.67     |      |      |
| Distance Between Pads    | G           | 7.40     |      |      |

#### Notes:

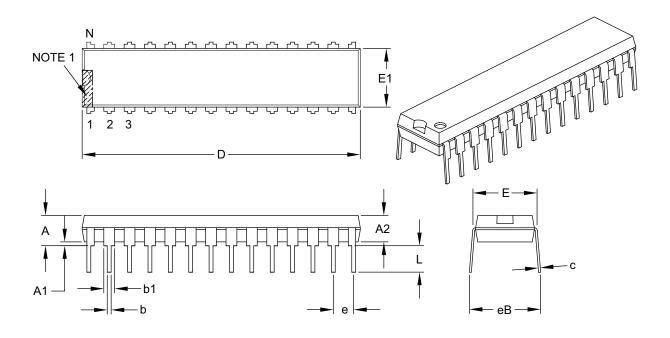
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2052A

#### 28-Lead Skinny Plastic Dual In-Line (SP) - 300 mil Body [SPDIP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



|                            | Units     |       | INCHES   |       |
|----------------------------|-----------|-------|----------|-------|
| Dimensio                   | on Limits | MIN   | NOM      | MAX   |
| Number of Pins             | N         |       | 28       |       |
| Pitch                      | е         |       | .100 BSC |       |
| Top to Seating Plane       | Α         | _     | _        | .200  |
| Molded Package Thickness   | A2        | .120  | .135     | .150  |
| Base to Seating Plane      | A1        | .015  | _        | _     |
| Shoulder to Shoulder Width | Е         | .290  | .310     | .335  |
| Molded Package Width       | E1        | .240  | .285     | .295  |
| Overall Length             | D         | 1.345 | 1.365    | 1.400 |
| Tip to Seating Plane       | L         | .110  | .130     | .150  |
| Lead Thickness             | С         | .008  | .010     | .015  |
| Upper Lead Width           | b1        | .040  | .050     | .070  |
| Lower Lead Width           | b         | .014  | .018     | .022  |
| Overall Row Spacing §      | еВ        | _     | _        | .430  |

#### Notes:

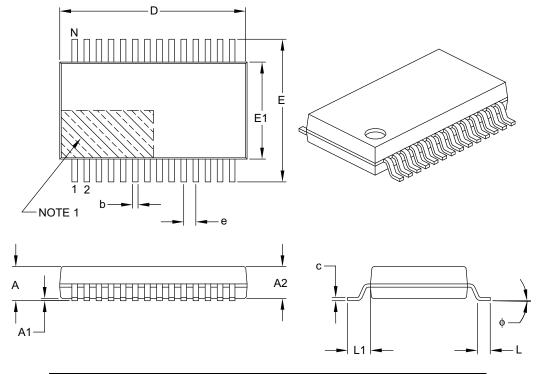
- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. § Significant Characteristic.
- 3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
- 4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-070B

#### 28-Lead Plastic Shrink Small Outline (SS) - 5.30 mm Body [SSOP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



|                          | Units    |          |          | MILLIMETERS |  |  |  |
|--------------------------|----------|----------|----------|-------------|--|--|--|
| Dimension                | n Limits | MIN      | NOM      | MAX         |  |  |  |
| Number of Pins           | N        |          | 28       |             |  |  |  |
| Pitch                    | е        |          | 0.65 BSC |             |  |  |  |
| Overall Height           | Α        | -        | _        | 2.00        |  |  |  |
| Molded Package Thickness | A2       | 1.65     | 1.75     | 1.85        |  |  |  |
| Standoff                 | A1       | 0.05     | _        | _           |  |  |  |
| Overall Width            | Е        | 7.40     | 7.80     | 8.20        |  |  |  |
| Molded Package Width     | E1       | 5.00     | 5.30     | 5.60        |  |  |  |
| Overall Length           | D        | 9.90     | 10.20    | 10.50       |  |  |  |
| Foot Length              | L        | 0.55     | 0.75     | 0.95        |  |  |  |
| Footprint                | L1       | 1.25 REF |          |             |  |  |  |
| Lead Thickness           | С        | 0.09     | _        | 0.25        |  |  |  |
| Foot Angle               | ф        | 0°       | 4°       | 8°          |  |  |  |
| Lead Width               | b        | 0.22     | -        | 0.38        |  |  |  |

#### Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- $2. \ \ Dimensions \ D \ and \ E1 \ do \ not \ include \ mold \ flash \ or \ protrusions. \ Mold \ flash \ or \ protrusions \ shall \ not \ exceed \ 0.20 \ mm \ per \ side.$
- 3. Dimensioning and tolerancing per ASME Y14.5M.

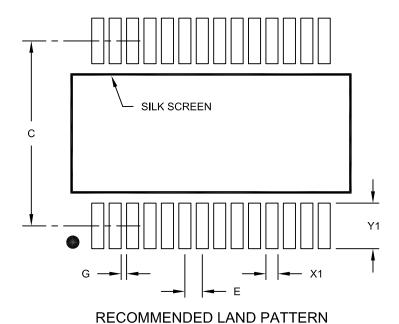
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-073B

### 28-Lead Plastic Shrink Small Outline (SS) - 5.30 mm Body [SSOP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



|                          | MILLIMETERS |      |      |      |
|--------------------------|-------------|------|------|------|
| Dimension                | MIN         | NOM  | MAX  |      |
| Contact Pitch            | 0.65 BSC    |      |      |      |
| Contact Pad Spacing      | С           |      | 7.20 |      |
| Contact Pad Width (X28)  | X1          |      |      | 0.45 |
| Contact Pad Length (X28) | Y1          |      |      | 1.75 |
| Distance Between Pads    | G           | 0.20 |      |      |

#### Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2073A

| NOTES: |  |  |  |
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#### APPENDIX A: REVISION HISTORY

#### Revision C (July 2016)

The following is the list of modifications:

- Added ESD data to Section 1.0, Electrical Characteristics.
- 2. Updated Table 2-1.
- 3. Updated package outline drawings.
- 4. Minor typographical errors

#### **Revision B (February 2007)**

- 1. Changed Byte and Sequential Read in Figure 1-1 from "R" to "W".
- Table 2-4, Param No. 51 and 53: Changed from 450 to 600 and 500 to 600, respecively.
- 3. Added disclaimers to package outline drawings.
- 4. Updated package outline drawings.

#### Revision A (June 2005)

· Original release of this document.

| NOTES: |  |  |  |
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#### PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

| PART NO.                 | – <u>X</u>                  | / <b>XX</b>                                   | X <sup>(1)</sup>  | Ex  | Examples:     |  |   |  |
|--------------------------|-----------------------------|---|---|-----|---------------|--|---|--|
| <br>Device               | <br>Temperature             | <br>Package                                   | Tape and Reel   | a)  | MCF           | P23017-E/ML:   | Extended temperature,<br>28LD QFN package   |  |
|                          | Range                       |   | Option  |     | MCF           | P23017T-E/ML:  | Extended temperature,<br>28LD QFN package,<br>Tape and Reel   |  |
| Device:                  | MCP23017<br>MCP23S17        |   | I/O Expander with I <sup>2</sup> C Interface<br>I/O Expander with SPI Interface   | c)  | MCF           | P23017-E/SP:   | Extended temperature, 28LD SPDIP package  |  |
|                          | _                           |   |   |     | MCF           | P23017-E/SO:   | Extended temperature,<br>28LD SOIC package  |  |
| Temperature<br>Range:    | E =                         | -40°C to +12                                  | 5°C (Extended)  | e)  | MCF           | P23017T-E/SO:  | Extended temperature,<br>28LD SOIC package,<br>Tape and Reel  |  |
| Package:                 | ML =                        | Plastic Quad<br>Body, QFN,                    | Flat, No Lead Package, 6x6 mm<br>28-lead  | f)  | MCF           | P23017-E/SS:   | Extended temperature, 28LD SSOP package   |  |
| SF                       | SO = Pla<br>28-<br>SP = Ski | Plastic Small<br>28-Lead<br>Skinny Plasti     | stic Small Outline, Wide, 7.50 mm Body, SOIC,<br>Lead<br>Iny Plastic Dual In-Line, 300 mil Body, SPDIP,<br>Lead<br>stic Shrink Small Outline, 5.30 mm Body, | "   | MCF           | P23017T-E/SS:  | Extended temperature,<br>28LD SSOP package,<br>Tape and Reel  |  |
|                          | SS =                        | SS = 28-Lead<br>Plastic Shrint<br>SSOP, 28-Le |   | a)  | MCF           | 23S17-E/ML:  | Extended temperature, 28LD QFN package  |  |
| Tape and Reel<br>Option: | T = Tape and Reel (         | 1)  | b)  | MCF | P23S17T-E/ML: | Extended temperature,<br>28LD QFN package,<br>Tape and Reel            |   |  |
|                          |                             |   |   | c)  | MCF           | P23S17-E/SP:   | Extended temperature, 28LD SPDIP package  |  |
|                          |                             |   | d)  | MCF | P23S17-E/SO:  | Extended temperature, 28LD SOIC package                                |   |  |
|                          |                             |   |   | e)  | MCF           | P23S17T-E/SO:  | Extended temperature,<br>28LD SOIC package,<br>Tape and Reel  |  |
|                          |                             |   |   | f)  | MCF           | P23S17-E/SS:   | Extended temperature, 28LD SSOP package   |  |
|                          |                             |   |   | g)  | MCF           | P23S17T-E/SS:  | Extended temperature,<br>28LD SSOP package<br>Tape and Reel   |  |
|                          |                             |   |   | No  | te 1:         | catalog part nun<br>is used for or<br>printed on the<br>your Microchip | identifier only appears in the nber description. This identifier dering purposes and is not device package. Check with Sales Office for package the Tape and Reel option. |  |

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